

ASML

Mark Designs

For Training Purposes Only

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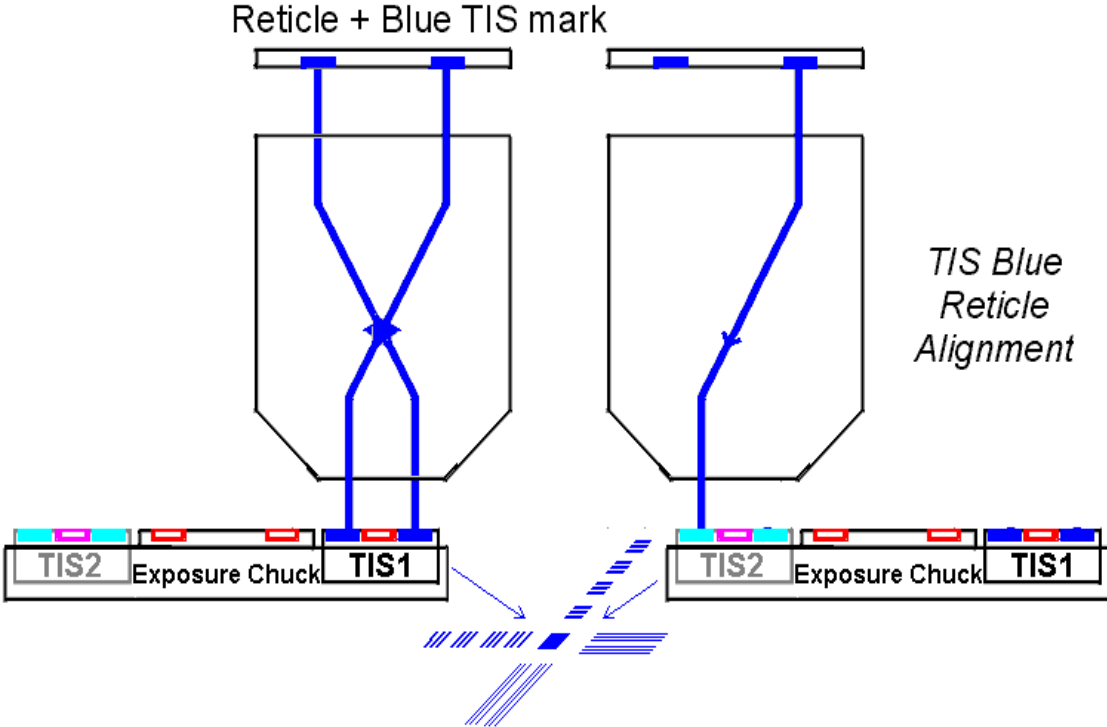
Goal

- Show the ASML basic mark types
- Explain their usage
- Show the ASML segmented marks

Contents

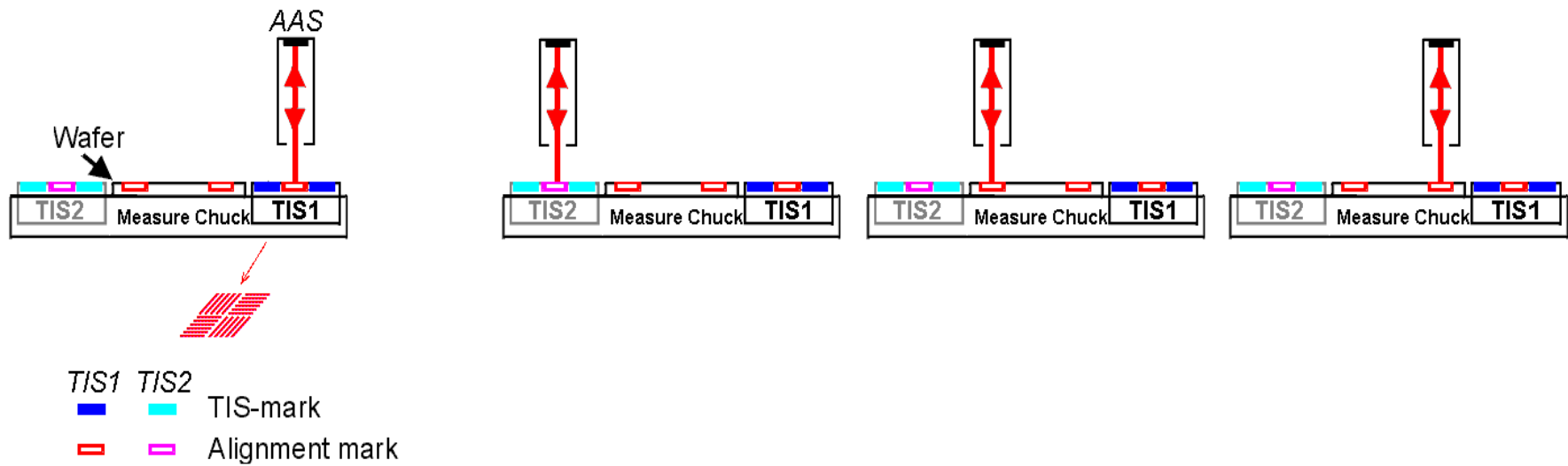
- Review alignment TIS, AA and TTL
- Basic mark types
 - TIS
 - PM
 - XPA
 - SPM
 - XPA-scribelane marks
- Segmentations
- Special marks
- Summary and Glossary of terms

Reticle Alignment on AT systems



Wafer Alignment on AT systems

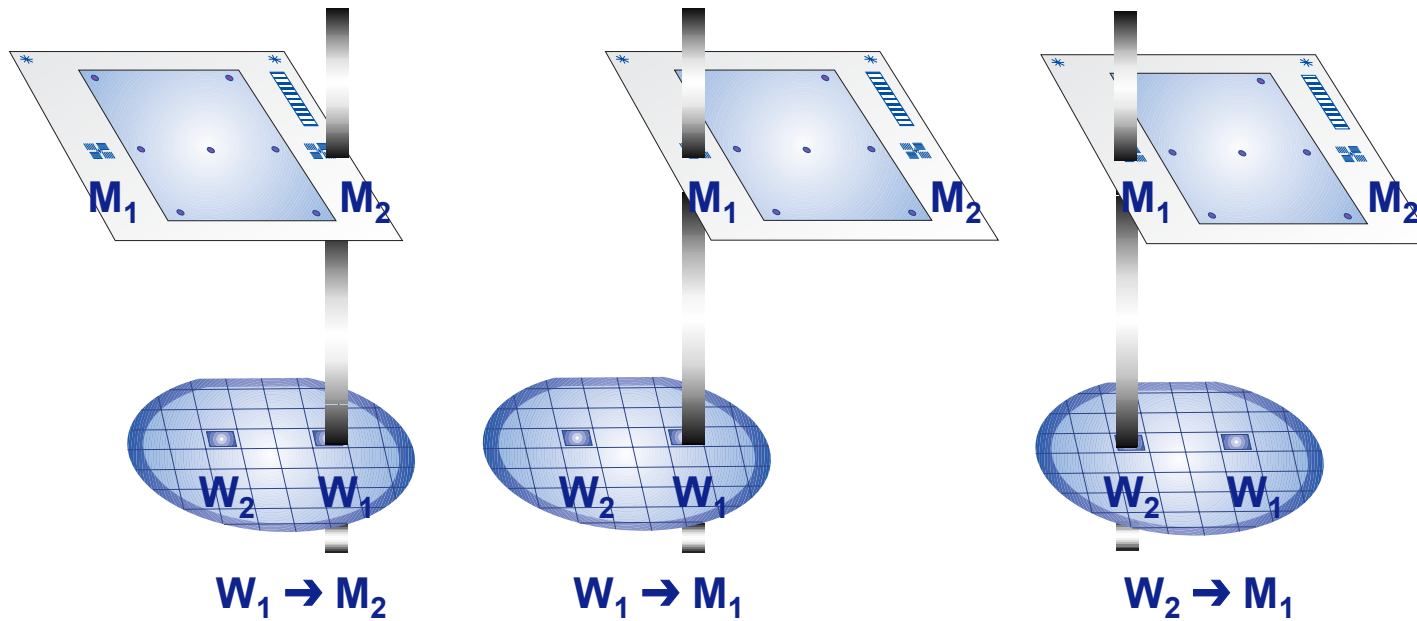
AT-T:



Alignment on TTL systems

Reticle alignment

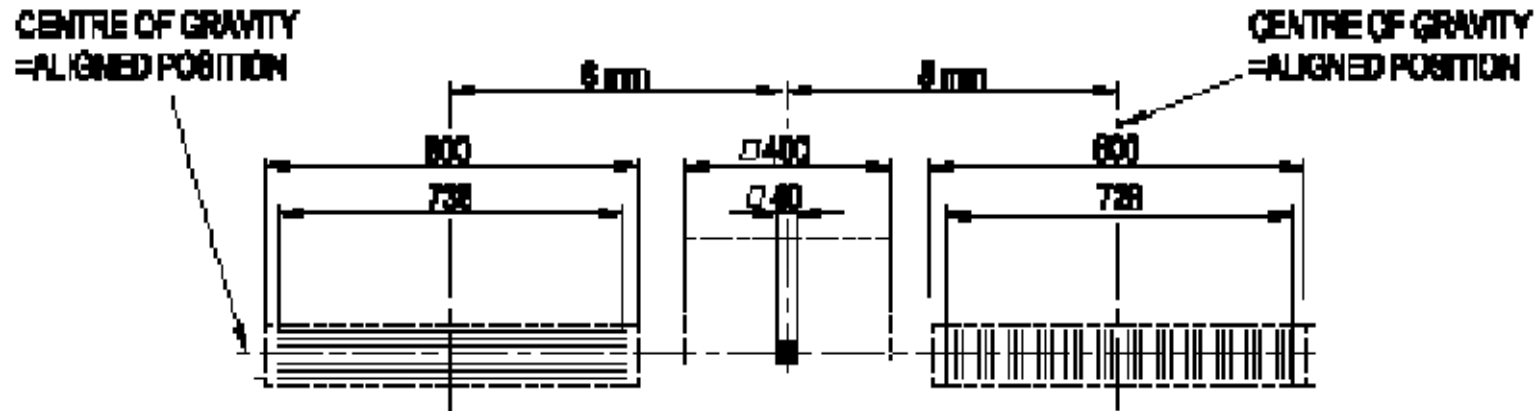
Wafer alignment with TTL,
OA also possible.



Basic mark types

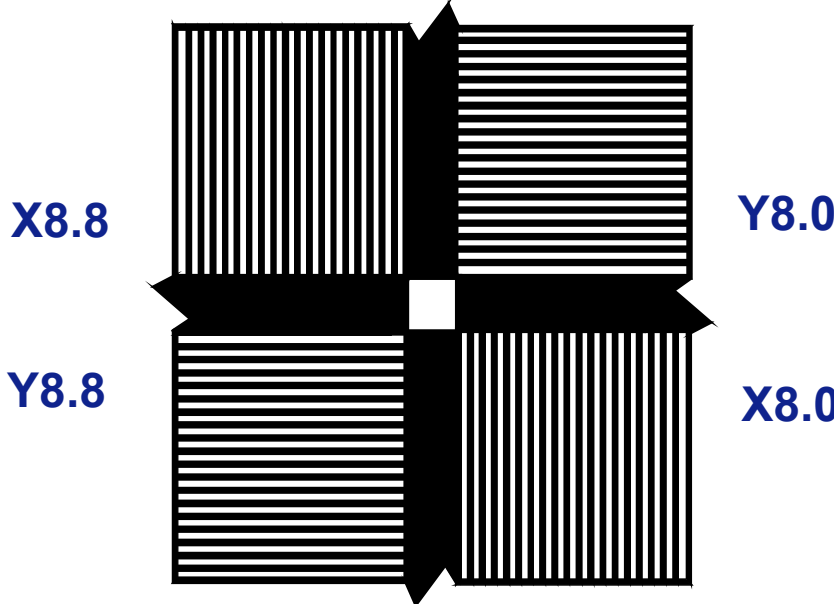
- There are several ASML basic types:
 - Transmission Image Sensor mark (TIS)
 - Primary Mark (PM)
 - eXtended Pattern Area mark (XPA)
 - Scribelane Primary Mark (SPM)
 - XPA scribelane marks
 - Segmented versions
 - Small SPM (SSPM)
 - Versatile SPM (VSPM)

Transmission Image Sensor mark



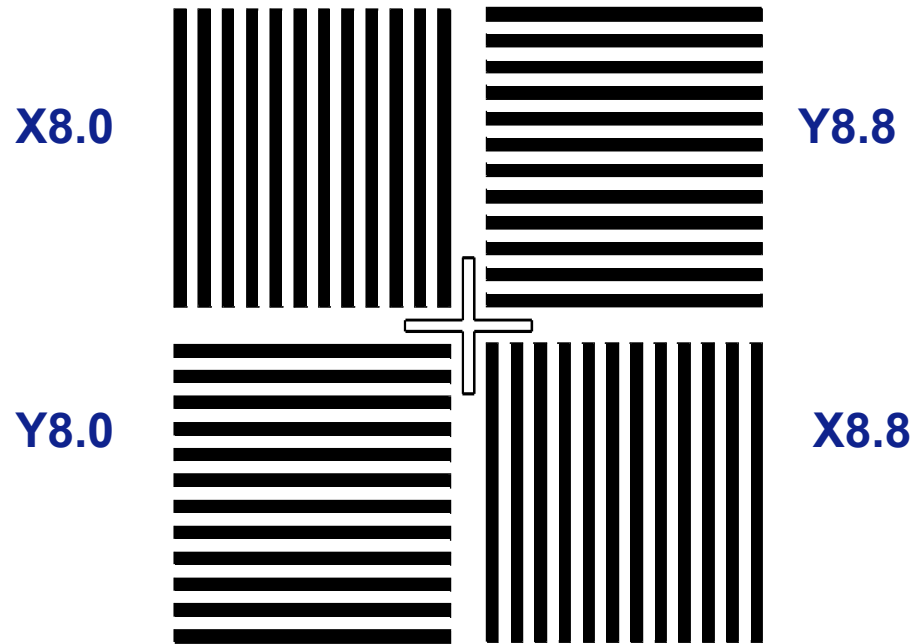
- Used for reticle alignment
- X and Y gratings
- Also gives Z-position

Reticle mark (RM)



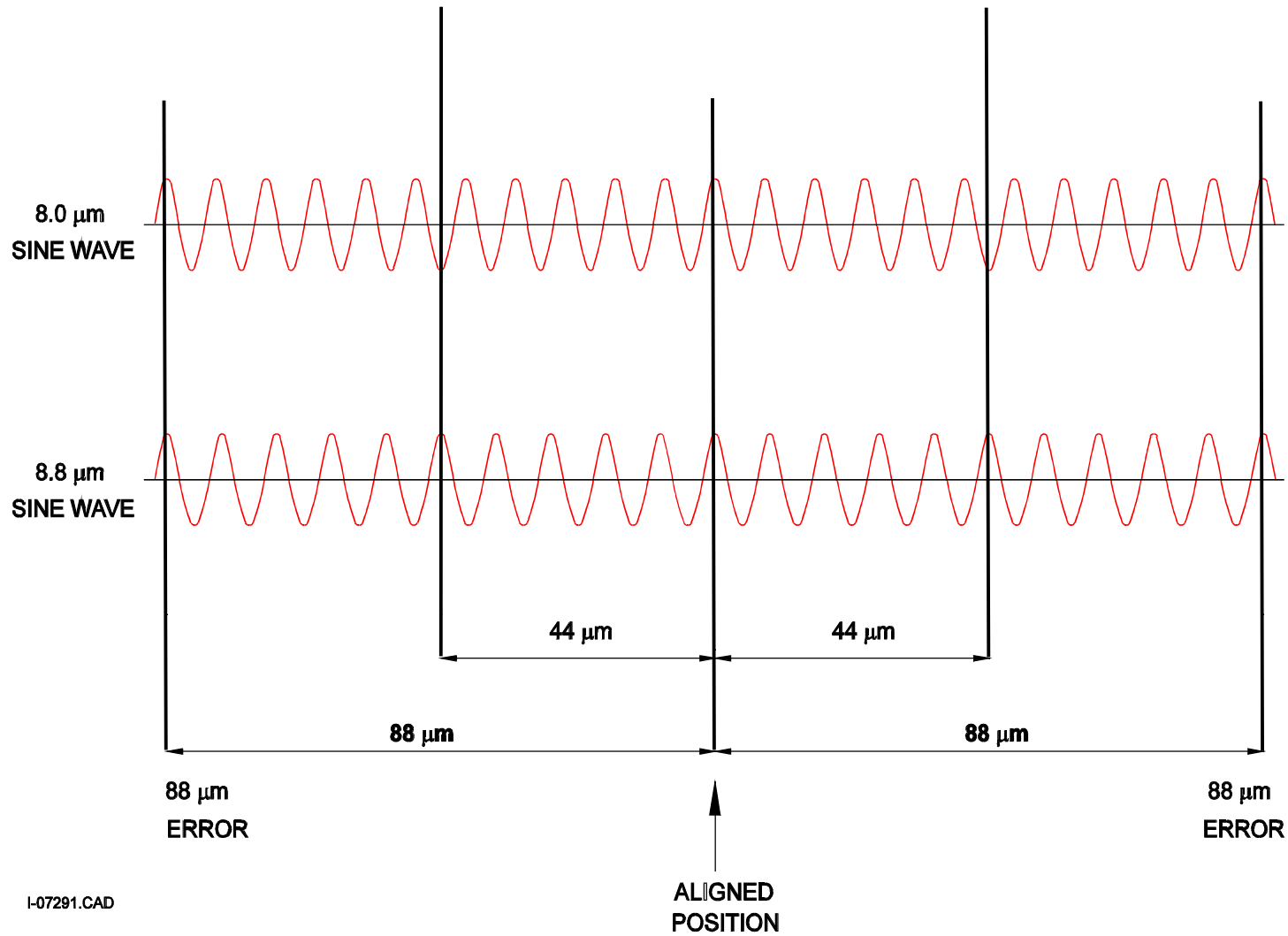
Reticle Alignment Mark (K1, K2) for TTL systems

Primary Mark



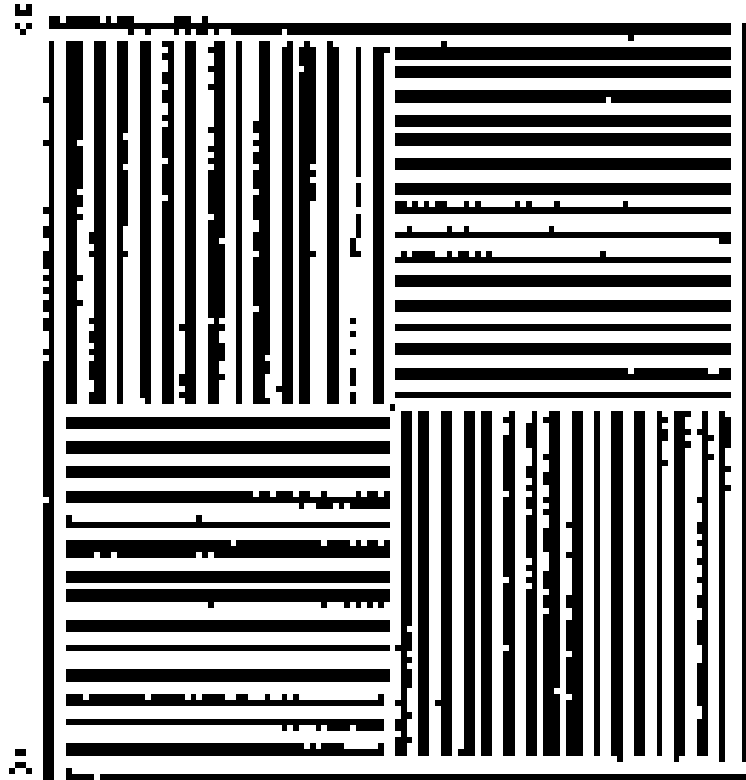
- Primary Mark, PM
- Capture range 88 micrometer
- X and Y gratings
- Suitable for optical pre-alignment

Capture range 88 micrometer



I-07291.CAD

eXtended Pattern Area mark



- eXtended Pattern Area (XPA)
- Capture range 88 micrometer
- X and Y gratings
- Suitable for optical pre-alignment

Scribelane Primary Mark



SPM-X

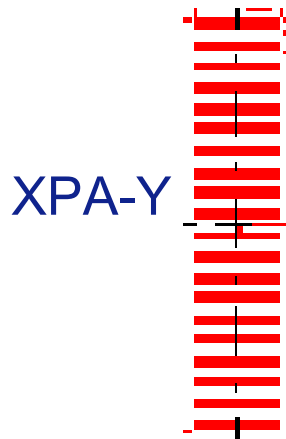
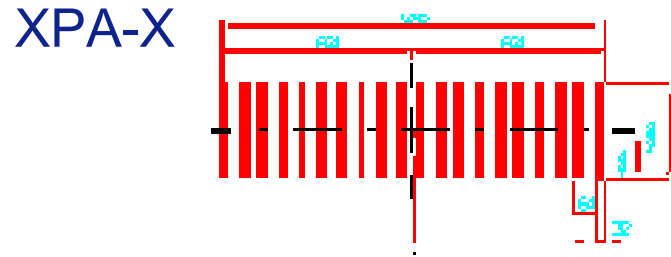
- Scribelane Primary Mark, SPM
- Capture range 88 micrometer (Small scan possible)



SPM-Y

- SPM-X: X-grating only
- SPM-Y: Y grating only

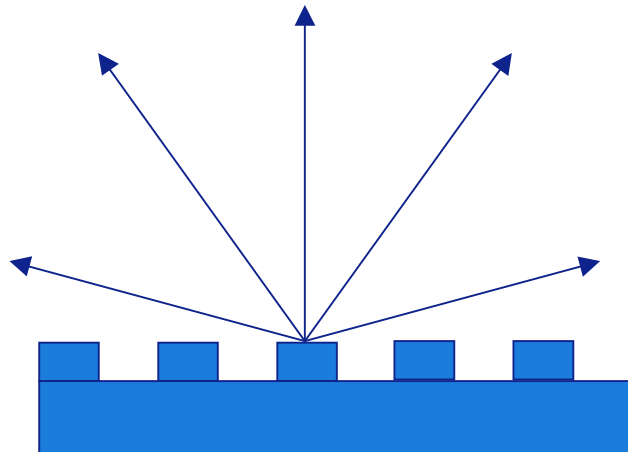
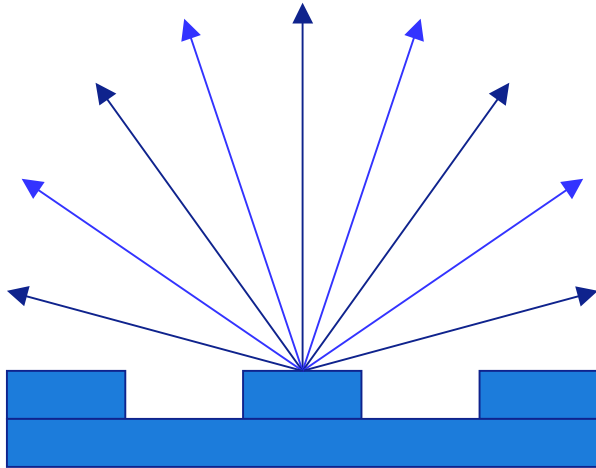
XPA scribelane marks



- Scribelane XPA mark
- Capture range 8 micrometer

- XPA-X: X-grating only
- XPA-Y: Y grating only

Segmented marks

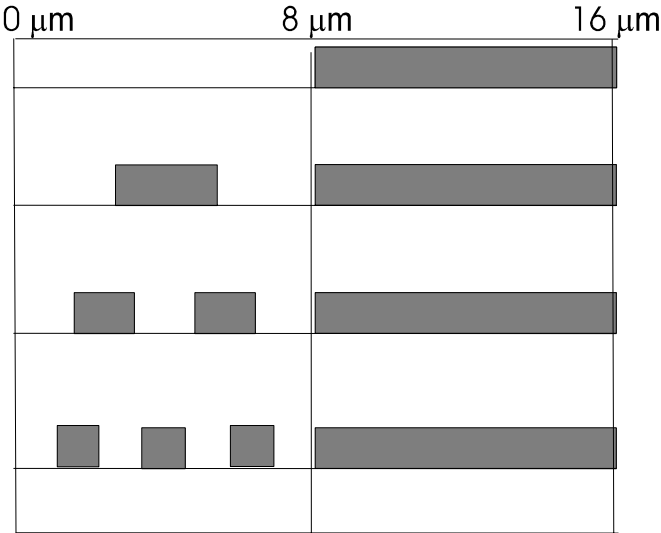


Doubling the frequency
=>
doubling the diffraction angle

$$(\sin \alpha = n\lambda / d)$$

This way we can enhance
the intensity for certain angles
= for certain orders.

Standard ASML segmented marks



Standard

AH32

AH53

AH74

Short SPM and Versatile SPM

